

DATA SHEET

BLV58

UHF linear push-pull power
transistor

Product specification

September 1991

UHF linear push-pull power transistor

BLV58

FEATURES

- High power gain
- Double stage internal input matching for high input impedance
- Diffused emitter-ballasting resistors enhances ruggedness
- Gold metallization for high reliability.

DESCRIPTION

The BLV58 is a common emitter epitaxial npn silicon planar transistor designed for high linearity class-A operation in UHF (bands 4 and 5) TV transmitters and transposers.

The device is incorporated in a push-pull SOT289 flange envelope with a ceramic cap, which is utilized with the emitters connected to the flange.

PINNING - SOT289

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | collector 1 |
| 2 | collector 2 |
| 3 | base 1 |
| 4 | base 2 |
| 5 | emitter |

QUICK REFERENCE DATA

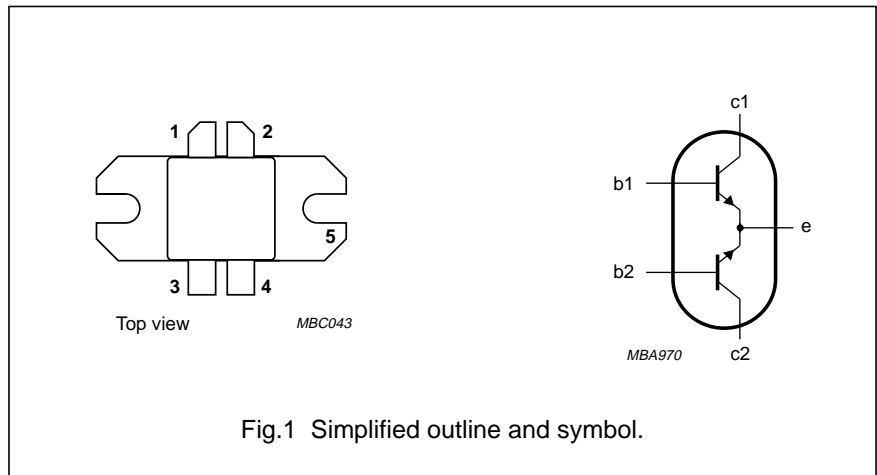
RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a common emitter test circuit.

| MODE OF OPERATION | f_{vision} (MHz) | V_{CE} (V) | I_{CQ} (A) | $P_{\text{O sync}}$ (W) | G_p (dB) | d_{im} (dB) (note 1) |
|-------------------|---------------------------|---------------------|---------------------|-------------------------|------------|-------------------------------|
| c.w. class-A | 860 | 25 | 2×1.6 | 25 | >10 | < -45 |

Note

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB); zero dB corresponds to peak sync level.

PIN CONFIGURATION



WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

UHF linear push-pull power transistor

BLV58

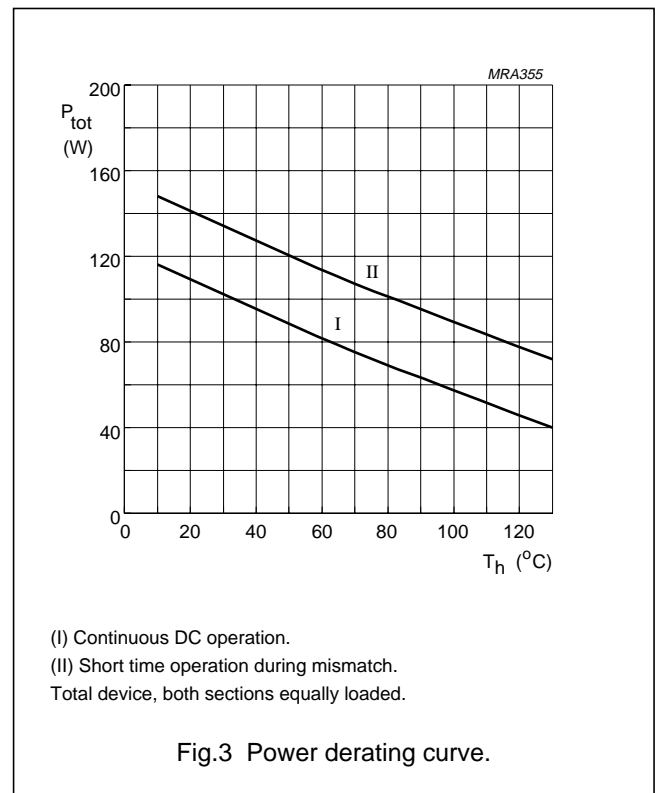
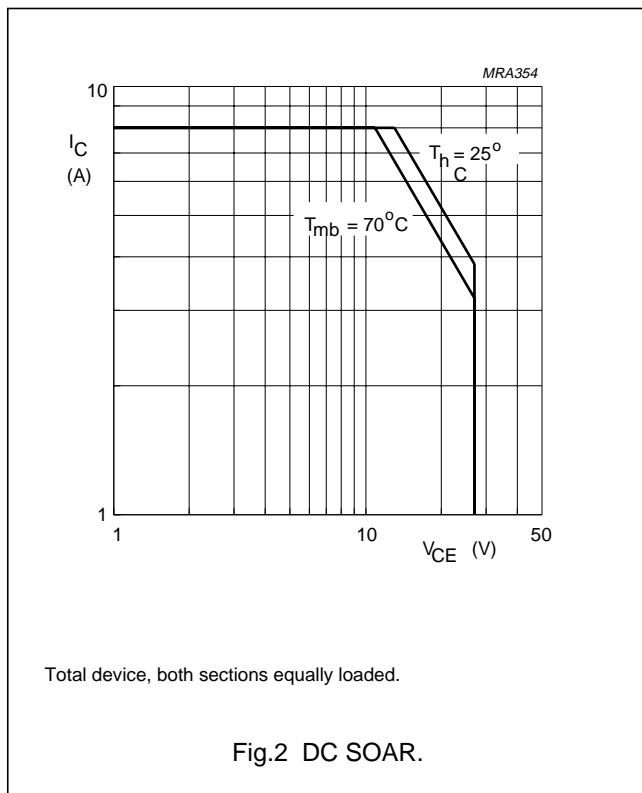
LIMITING VALUES (per transistor section unless otherwise specified)

In accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|--------------------------------|--|------|------|------------------|
| V_{CBO} | collector-base voltage | open emitter | – | 50 | V |
| V_{CEO} | collector-emitter voltage | open base | – | 27 | V |
| V_{EBO} | emitter-base voltage | open collector | – | 3.5 | V |
| $I_C, I_{C(AV)}$ | collector current | DC or average value | – | 4 | A |
| I_{CM} | collector current | peak value; $f > 1$ MHz | – | 8 | A |
| P_{tot} | total power dissipation | DC operation; $T_{mb} = 70^\circ\text{C}$ (note 1) | – | 87 | W |
| T_{stg} | storage temperature range | | –65 | 150 | $^\circ\text{C}$ |
| T_j | junction operating temperature | | – | 200 | $^\circ\text{C}$ |

Note

1. Total device, both sections equally loaded.



UHF linear push-pull power transistor

BLV58

THERMAL RESISTANCE

| SYMBOL | PARAMETER | CONDITIONS | MAX. | UNIT |
|--------------------|--------------------------------|--|------|------|
| $R_{th\ j-mb(DC)}$ | from junction to mounting base | $P_{dis} = 87\ W$; $T_{mb} = 70\ ^\circ C$ (note 1) | 1.5 | K/W |
| $R_{th\ mb-h}$ | from mounting base to heatsink | note 1 | 0.2 | K/W |

Note

- Total device, both sections equally loaded.

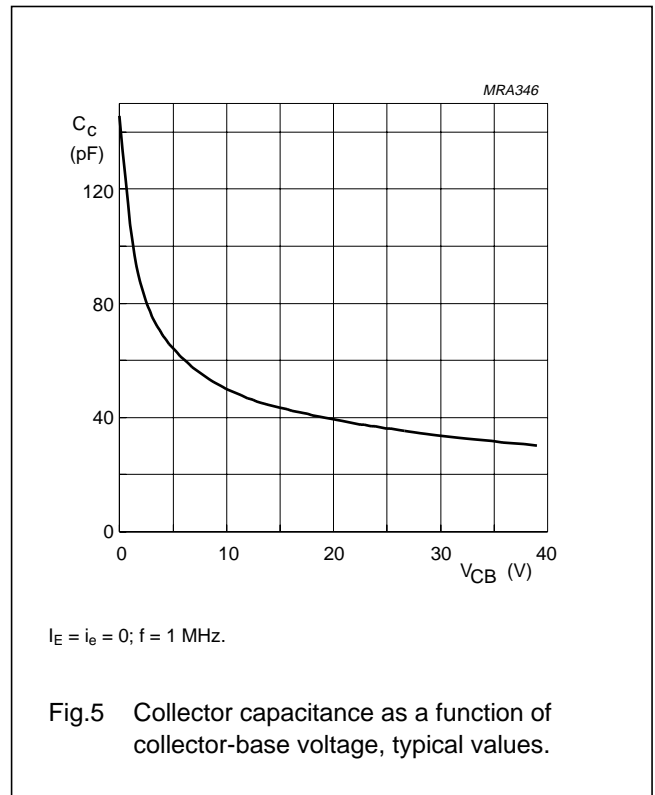
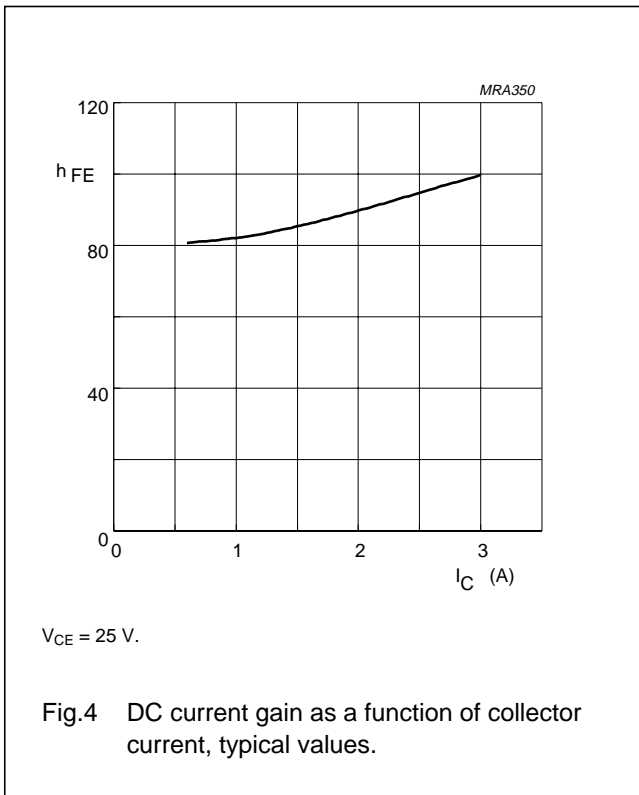
CHARACTERISTICS

Values apply to either transistor section; $T_j = 25\ ^\circ C$.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|-------------------------------------|---|------|------|------|------|
| $V_{(BR)CBO}$ | collector-base breakdown voltage | open emitter; $I_C = 20\ mA$ | 50 | – | – | V |
| $V_{(BR)CEO}$ | collector-emitter breakdown voltage | open base; $I_C = 50\ mA$ | 27 | – | – | V |
| $V_{(BR)EBO}$ | emitter-base breakdown voltage | open collector; $I_E = 10\ mA$ | 3.5 | – | – | V |
| I_{CES} | collector-emitter leakage current | $V_{BE} = 0$; $V_{CE} = 27\ V$ | – | – | 10 | mA |
| h_{FE} | DC current gain | $V_{CE} = 25\ V$; $I_C = 1.6\ A$ | 30 | – | – | |
| C_c | collector capacitance | $V_{CB} = 25\ V$; $I_E = I_e = 0$; $f = 1\ MHz$ | – | 36 | 45 | pF |

UHF linear push-pull power transistor

BLV58



UHF linear push-pull power transistor

BLV58

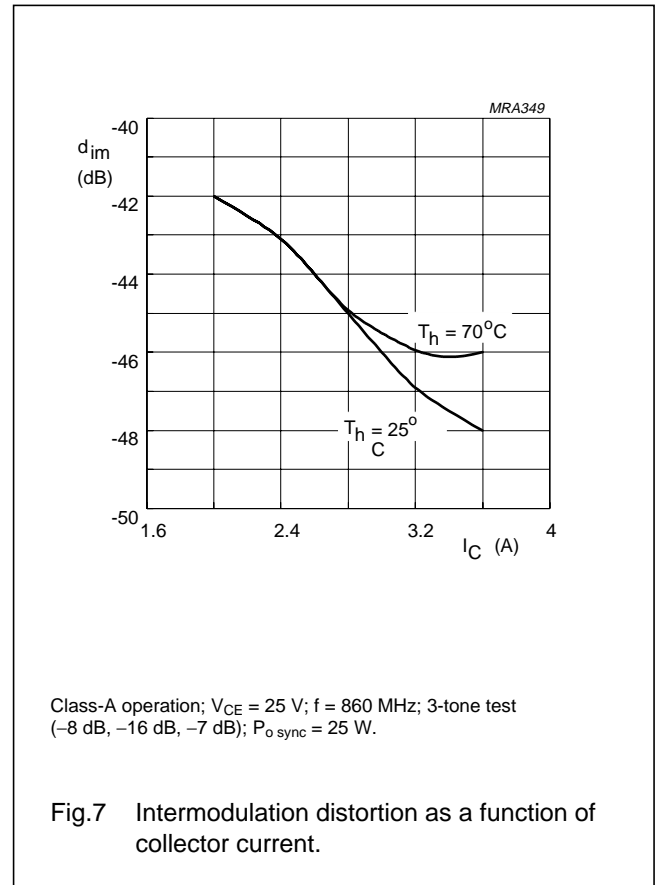
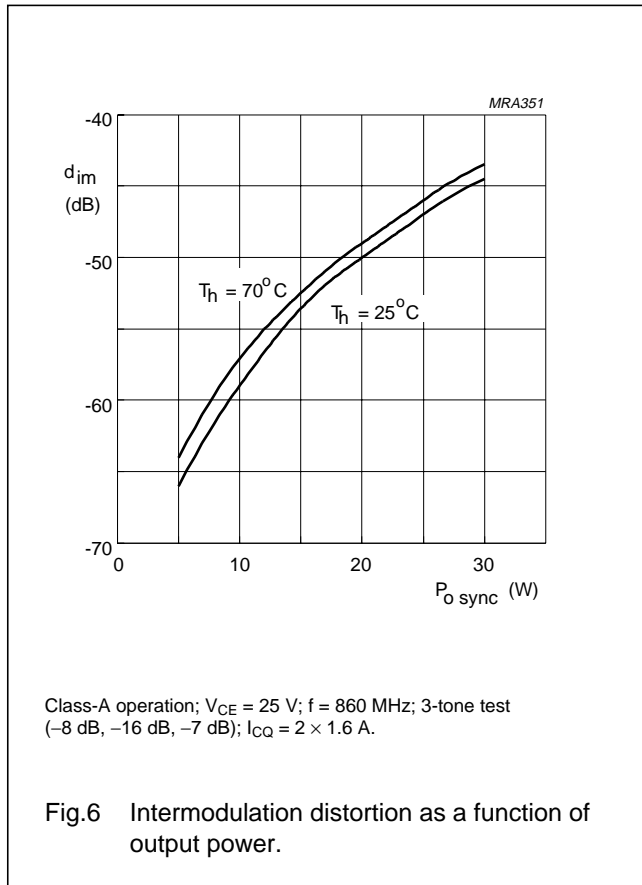
APPLICATION INFORMATION

RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a common emitter push-pull test circuit; $R_{th\text{ mb-h}} = 0.2\text{ K/W}$.

| MODE OF OPERATION | f_{vision} (MHz) | V_{CE} (V) | I_{CQ} (A) | $P_{\text{O sync}}$ (W) | G_P (dB) | d_{im} (dB) (note 1) | d_{cm} (%) (note 2) |
|-------------------|---------------------------|---------------------|---------------------|-------------------------|-------------------|-------------------------------|------------------------------|
| c.w. class-A | 860 | 25 | 2×1.6 | 25 | > 10 typ. 11.5 | < -45 typ. -47 | < 20 |

Notes

1. Three-tone test method: vision carrier -8 dB (860 MHz), sound carrier -7 dB (865.5 MHz), sideband signal -16 dB (861 MHz); zero dB corresponds to peak sync level.
2. Two-tone test method: vision carrier 0 dB (860 MHz), sound carrier -7 dB (865.5 MHz); zero dB corresponds to peak sync level. Cross-modulation distortion (d_{cm}) is the voltage variation (%) of the sound carrier when the vision carrier is switched from 0 dB to -20 dB.



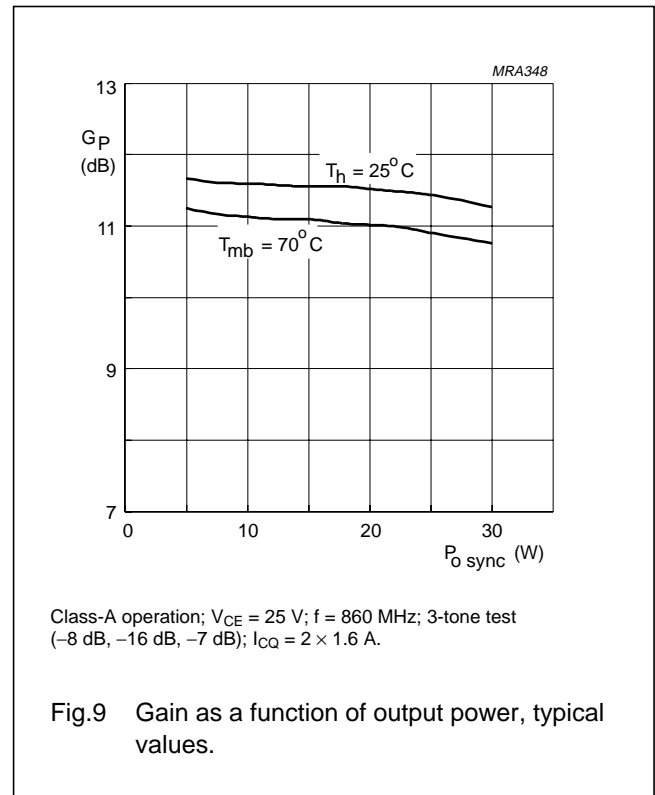
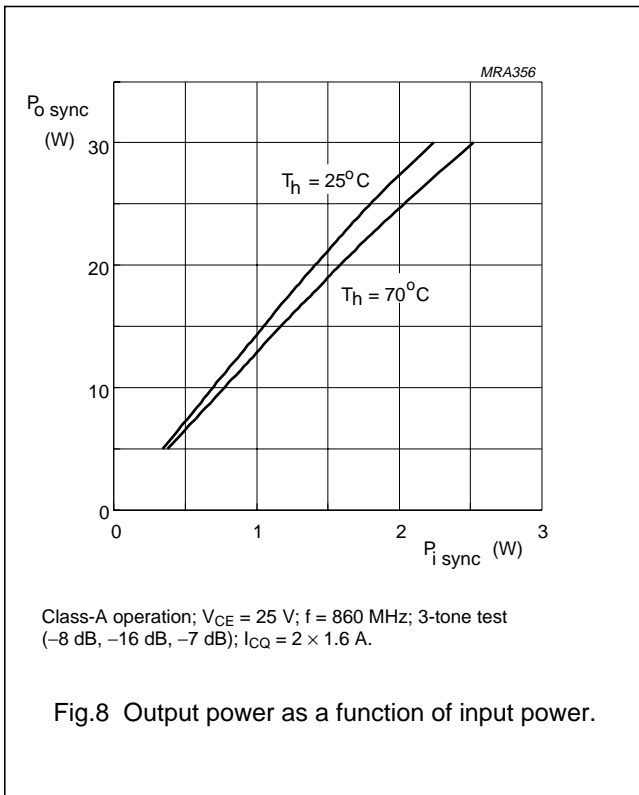
Ruggedness in Class-A operation

The BLV58 is capable of withstanding a full load mismatch corresponding to $V_{\text{SWR}} = 50:1$ through all phases under the following conditions:

$V_{\text{CE}} = 25\text{ V}$, $f = 860\text{ MHz}$, $T_h = 25\text{ }^\circ\text{C}$,
 $R_{th\text{ mb-h}} = 0.2\text{ K/W}$, $I_{\text{CQ}} = 2 \times 1.6\text{ A}$,
 and rated output power.

UHF linear push-pull power transistor

BLV58



UHF linear push-pull power transistor

BLV58

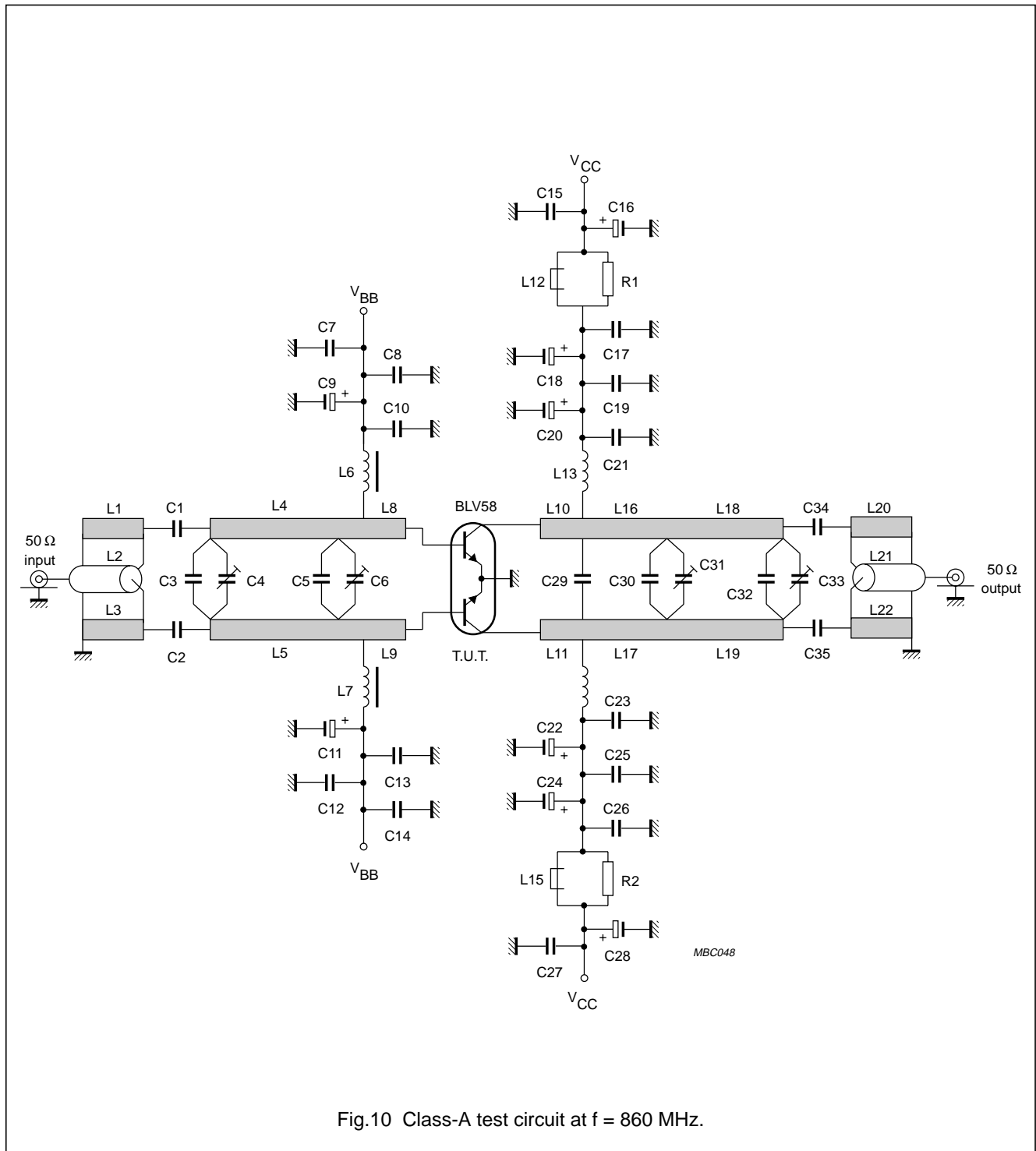


Fig.10 Class-A test circuit at f = 860 MHz.

UHF linear push-pull power transistor

BLV58

List of components (see test circuit)

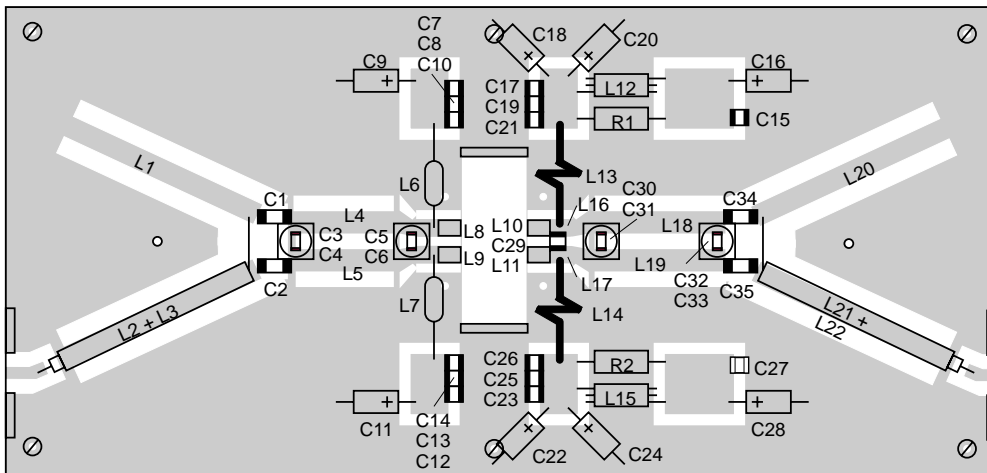
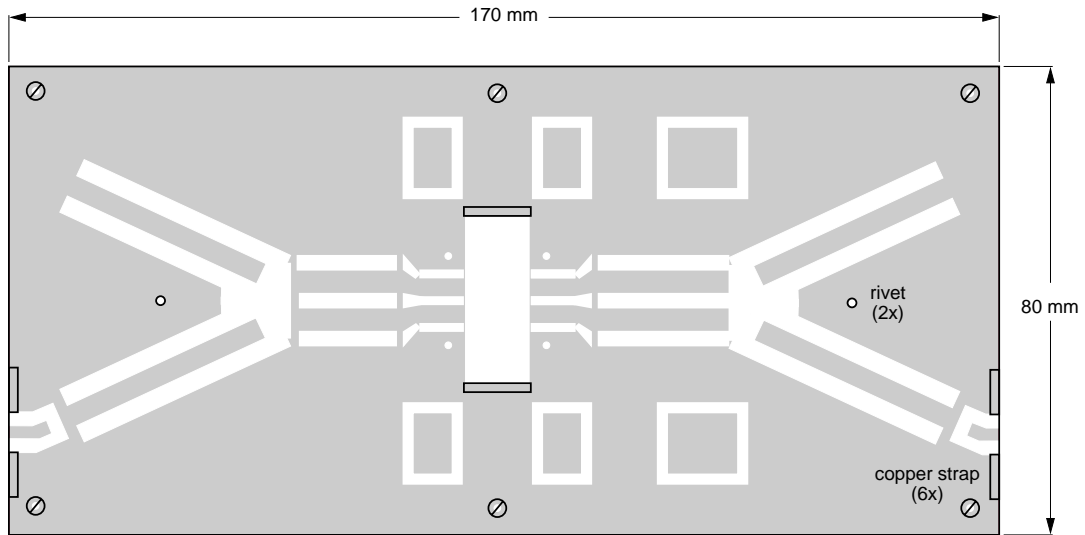
| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
|------------------------------|--|-------------|---|----------------|
| C1, C2, C34, C35 | multilayer ceramic chip capacitor (note 1) | 15 pF | | |
| C3 | multilayer ceramic chip capacitor (note 1) | 3.9 pF | | |
| C4, C6 | film dielectric trimmer | 5.5 pF | | 2222 809 09005 |
| C5 | multilayer ceramic chip capacitor (note 1) | 7.5 pF | | |
| C7, C12, C17, C26 | multilayer ceramic chip capacitor | 10 nF | | 2222 852 47103 |
| C8, C14, C19, C25 | multilayer ceramic chip capacitor | 100 nF | | 2222 852 47104 |
| C9, C11, C16, C20, C22, C28 | 63 V electrolytic capacitor | 10 μ F | | |
| C10, C13, C15, C21, C23, C27 | multilayer ceramic chip capacitor (note 1) | 330 pF | | |
| C18, C24 | 63 V electrolytic capacitor | 1 μ F | | |
| C29 | multilayer ceramic chip capacitor (note 1) | 12 pF | | |
| C30 | multilayer ceramic chip capacitor (note 1) | 5.6 pF | | |
| C31, C33 | film dielectric trimmer | 3.5 pF | | 2222 809 05001 |
| C32 | multilayer ceramic chip capacitor (note 1) | 2.7 pF | | |
| L1, L3, L20, L22 | stripline (note 2) | 35 Ω | 39 mm \times 4 mm | |
| L2, L21 | semi-rigid cable (note 3) | 50 Ω | ext. dia. 3.6 mm; length 39 mm | |
| L4, L5 | stripline (note 2) | 38 Ω | 19 mm \times 3.5 mm | |
| L6, L7 | RF choke | 470 nH | | |
| L8, L9 | stripline (note 2) | 38 Ω | 7.5 mm \times 3.5 mm | |
| L10, L11 | stripline (note 2) | 38 Ω | 4.5 mm \times 3.5 mm | |
| L12, L15 | grade 3B RF choke | | | 4312 020 36642 |
| L13, L14 | 1 turn 1.5 mm copper wire | 14 nH | int. dia 7 mm; leads 2 \times 6 mm | |
| L16, L17 | stripline (note 2) | 38 Ω | 7 mm \times 3.5 mm | |
| L18, L19 | stripline (note 2) | 38 Ω | 18 mm \times 3.5 mm | |
| R1, R2 | 1 W metal film resistor | 10 Ω | | |

Notes

- American Technical Ceramics type 100B or capacitor of the same quality.
- The striplines are on a double copper-clad printed circuit board, with PTFE microfibre-glass dielectric ($\epsilon_r = 2.2$), thickness $\frac{1}{32}$ inch, thickness of copper sheet $2 \times 35 \mu\text{m}$.
- Cables L2 and L21 are soldered to striplines L1 and L20, respectively.

UHF linear push-pull power transistor

BLV58

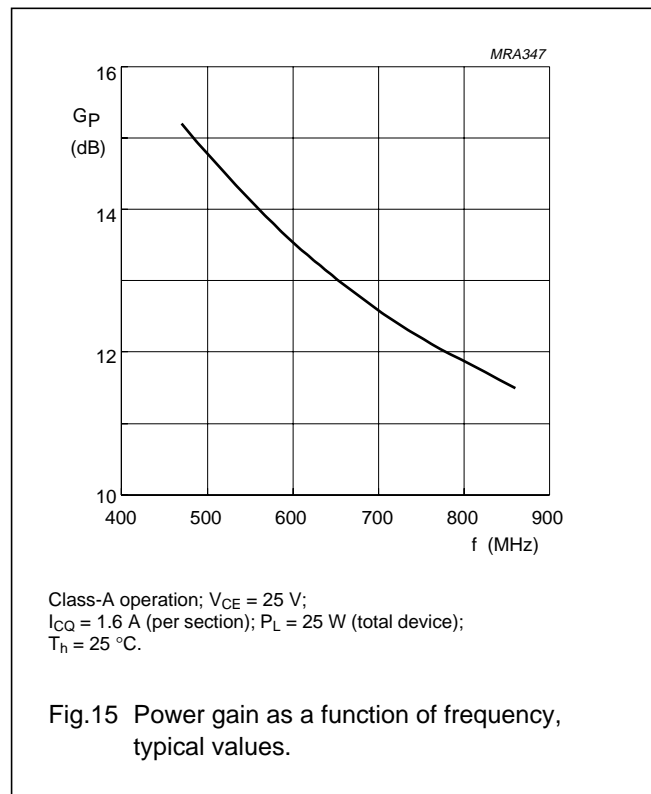
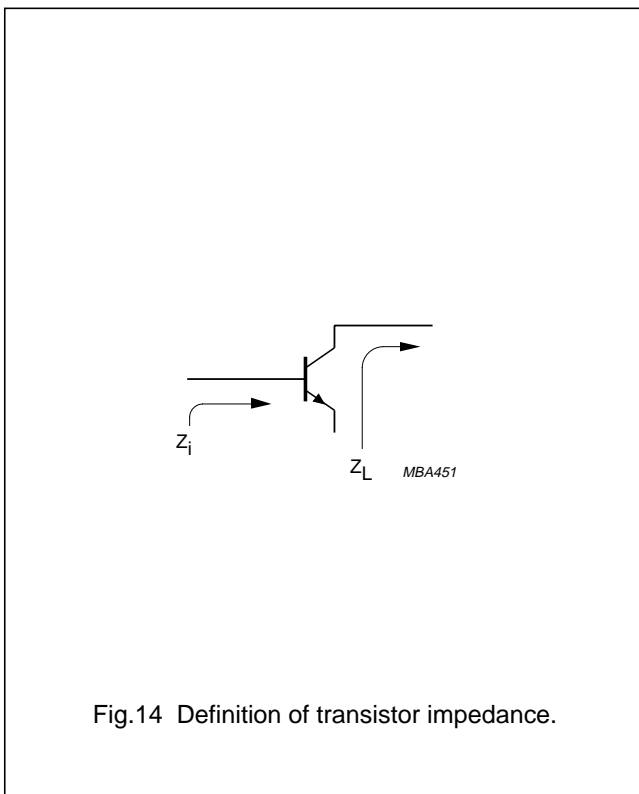
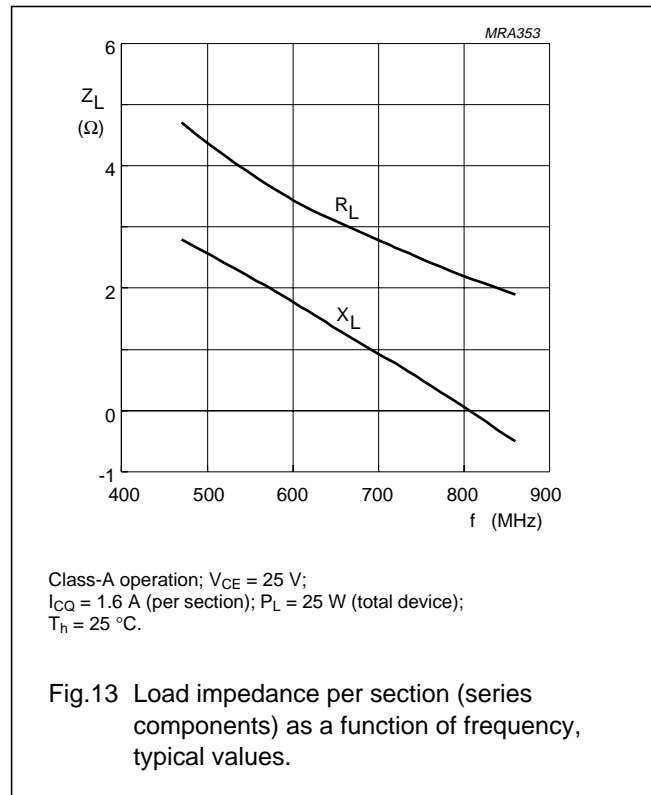
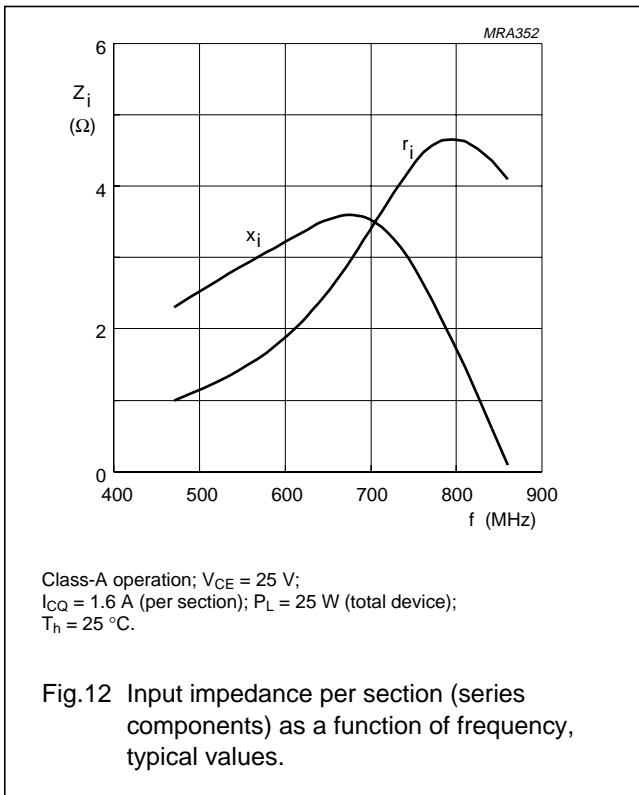


The components are mounted on one side of a copper clad PTFE microfibre-glass board; the other side is unetched and serves as a ground plane. Earth connections from the component side to the ground plane are made by hollow rivets and copper straps.

Fig.11 Component layout for 860 MHz class-A test circuit.

UHF linear push-pull power transistor

BLV58



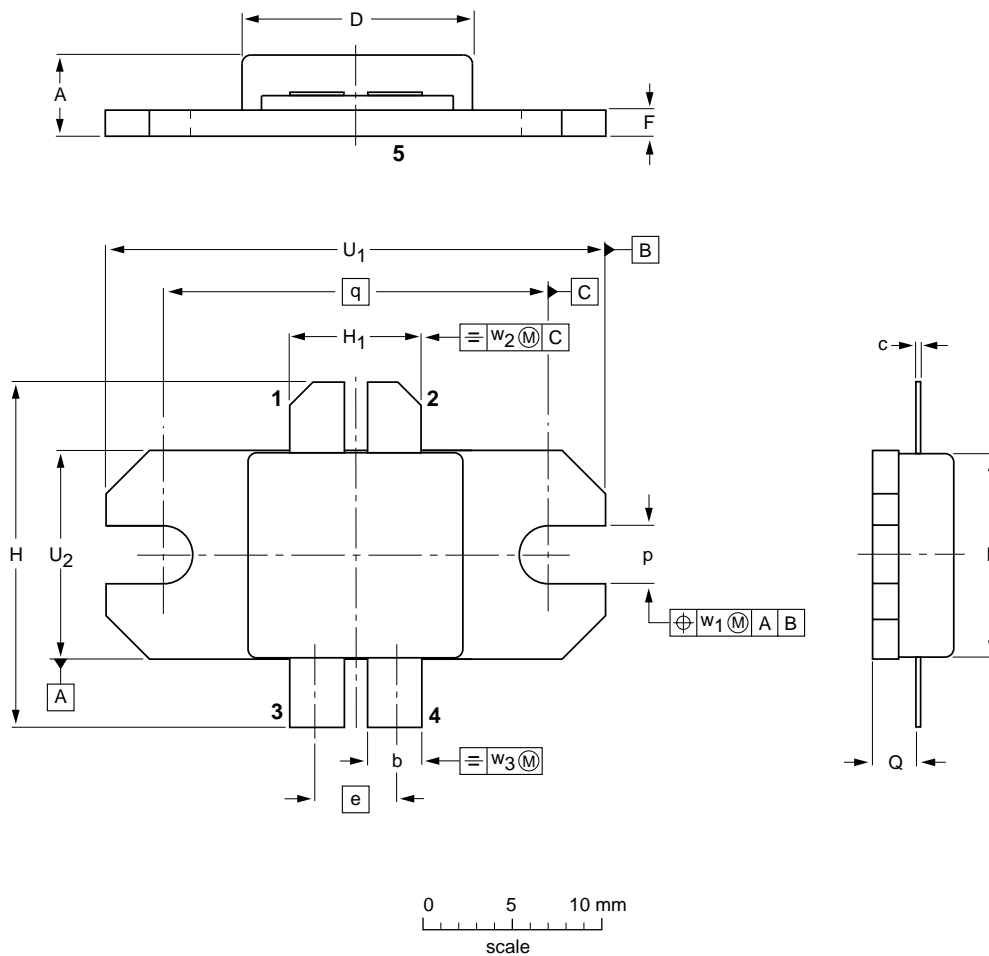
UHF linear push-pull power transistor

BLV58

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT289A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | A | b | c | D | E | e | F | H | H ₁ | p | Q | q | U ₁ | U ₂ | w ₁ | w ₂ | w ₃ |
|--------|----------------|----------------|----------------|----------------|----------------|-------|----------------|----------------|----------------|----------------|----------------|-------|----------------|----------------|----------------|----------------|----------------|
| mm | 4.65 3.92 | 3.33 3.07 | 0.10 0.05 | 13.10 12.90 | 11.53 11.33 | 4.60 | 1.65 1.40 | 19.81 19.05 | 4.85 4.34 | 3.43 3.17 | 2.31 2.06 | 21.44 | 28.07 27.81 | 11.81 11.56 | 0.51 | 1.02 | 0.25 |
| inches | 0.183 0.154 | 0.131 0.121 | 0.004 0.002 | 0.516 0.508 | 0.454 0.446 | 0.181 | 0.065 0.055 | 0.780 0.750 | 0.191 0.171 | 0.135 0.125 | 0.091 0.081 | 0.844 | 1.105 1.095 | 0.465 0.455 | 0.02 | 0.04 | 0.01 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|------|--|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT289A | | | | | | 97-06-28 |

UHF linear push-pull power transistor

BLV58

DEFINITIONS

| Data Sheet Status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.